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1. Product profile

1.1 General description

The device is designed to protect high-speed interfaces such as SuperSpeed USB, High-Definition Multimedia Interface (HDMI), DisplayPort, external Serial Advanced Technology Attachment (eSATA) and Low Voltage Differential Signaling (LVDS) interfaces against ElectroStatic Discharge (ESD).

The device includes four high-level ESD protection diode structures for ultra high-speed signal lines and is encapsulated in a leadless small DFN2510A-10 (SOT1176-1) plastic package.

All signal lines are protected by a special diode configuration offering ultra low line capacitance of only 0.5 pF. These diodes utilize a unique snap-back structure in order to provide protection to downstream components from ESD voltages up to ± 10 kV contact exceeding IEC 61000-4-2, level 4.

1.2 Features and benefits

- System ESD protection for USB 2.0 and SuperSpeed USB 3.1, HDMI 2.0, DisplayPort, eSATA and LVDS
- All signal lines with integrated rail-to-rail clamping diodes for downstream ESD protection of ± 10 kV exceeding IEC 61000-4-2, level 4
- Matched 0.5 mm trace spacing
- Signal lines with ≤ 0.05 pF matching capacitance between signal pairs
- Line capacitance of only 0.5 pF for each channel
- Design-friendly 'pass-through' signal routing

1.3 Applications

The device is designed for high-speed receiver and transmitter port protection:

- TVs and monitors
- DVD recorders and players
- Notebooks, main board graphic cards and ports
- Set-top boxes and game consoles



ESD protection for ultra high-speed interfaces

2. Pinning information

Table 1. Pinning

Pin	Symbol	Description	Simplified outline	Graphic symbol		
1	CH1	channel 1 ESD protection	40.0.0.7.0			
2	CH2	channel 2 ESD protection	10 9 8 7 6	1 2 4 5		
3	GND	ground				
4	CH3	channel 3 ESD protection	1 2 3 4 5			
5	CH4	channel 4 ESD protection	Transparent top view			
6	n.c.	not connected		3.8		
7	n.c.	not connected		3, 0 018aaa001		
8	GND	ground				
9	n.c.	not connected				
10	n.c.	not connected				

3. Ordering information

Table 2. Ordering information

Type number			
	Name	Description	Version
PUSB3F97	DFN2510A-10	plastic extremely thin small outline package; no leads; 10 terminals; body 1 \times 2.5 \times 0.5 mm	SOT1176-1

4. Marking

Table 3. Marking codes

Type number	Marking code
PUSB3F97	96

5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _I	input voltage			-0.5	+5.5	V
V _{ESD}	electrostatic discharge voltage	IEC 61000-4-2, level 4	[1]			
		contact discharge		-10	+10	kV
		air discharge		-15	+15	kV
T _{amb}	ambient temperature			-40	+85	°C
T _{stg}	storage temperature			-55	+125	°C

^[1] All pins to ground.

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6. Characteristics

Table 5. Characteristics

 T_{amb} = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V_{BR}	breakdown voltage	I _I = 1 mA		6	-	-	٧
I _{LR}	reverse leakage current	per channel; V _I = 3 V		-	-	1	μΑ
V _F	forward voltage	I _I = 1 mA		-	0.7	-	٧
C _{line}	line capacitance	f = 1 MHz; V _I = 3.3 V	[1]	-	0.5	0.6	pF
∆C _{line}	line capacitance difference	f = 1 MHz; V _I = 3.3 V	[1]	-	0.05	-	pF
dyn	dynamic resistance	surge	[2]				
		positive transient		-	0.41	-	Ω
		negative transient		-	0.26	-	Ω
		TLP	[3]				
		positive transient		-	0.43	-	Ω
		negative transient		-	0.28	-	Ω
V _{CL}	clamping voltage	I _{PP} = 5.2 A	[2]				
		positive transient		-	4.6	-	٧
		$I_{PP} = -4.4 \text{ A}$	[2]				
		negative transient		-	-2.2	-	V

^[1] This parameter is guaranteed by design.

^[2] According to IEC 61000-4-5 (8/20 μs current waveform).

^{[3] 100} ns Transmission Line Pulse (TLP); 50 Ω ; pulser at 80 ns.

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aaa-009368

4 _{V_I (V)} 5

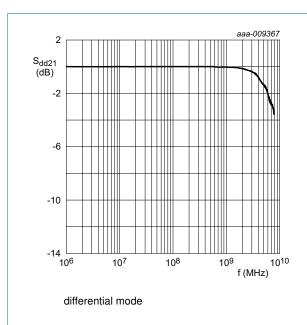
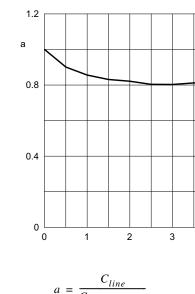
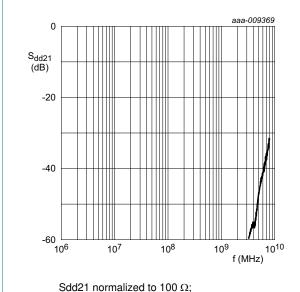


Fig 1. Insertion loss; typical values



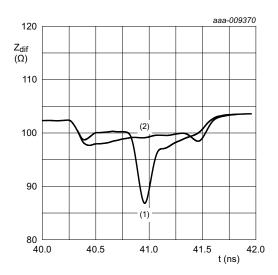
 $a = \frac{C_{line}}{C_{line(V_I = 0 \text{ V})}}$

Fig 2. Relative capacitance as a function of input voltage; typical values



differential pairs CH1/CH2 versus CH3/CH4

Crosstalk; typical values Fig 3.

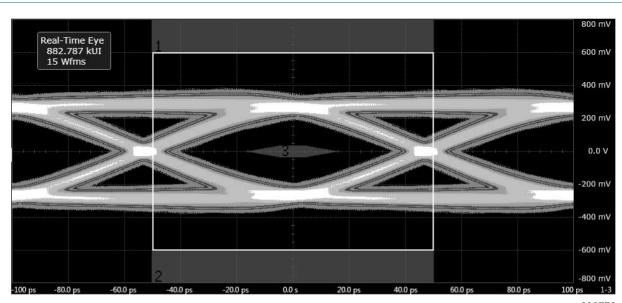


 $t_r = 200 \text{ ps}$; differential pair CH1 + CH2

- (1) PUSB3F97 on reference board
- (2) Reference board without device under test (DUT)

Differential Time Domain Reflectometer (TDR) Fig 4. plot; typical values

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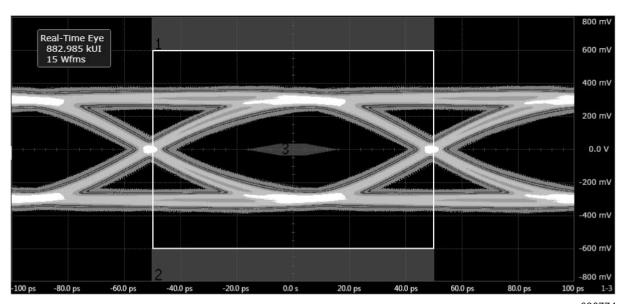


aaa-026773

Data rate: 10 Gbit/s; Vertical scale: 200 mV/div; Horizontal scale: 20 ps/div

3.1 dB de-emphasis2.2 dB pre-shoot

Fig 5. USB 3.1 eye diagram, Printed-Circuit Board (PCB) with PUSB3F97



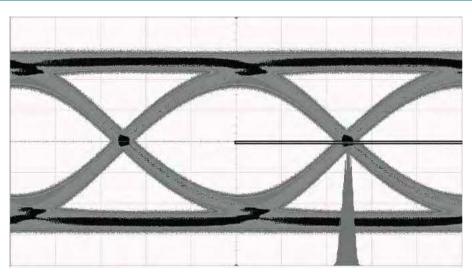
aaa-026774

Data rate: 10 Gbit/s; Vertical scale: 200 mV/div; Horizontal scale: 20 ps/div

3.1 dB de-emphasis2.2 dB pre-shoot

Fig 6. USB 3.1 eye diagram, PCB without PUSB3F97 (reference)

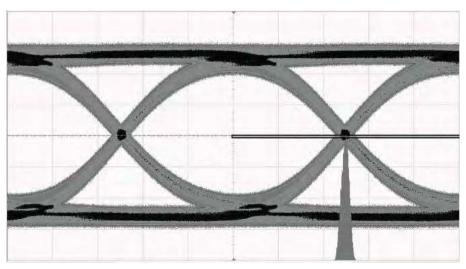
ESD protection for ultra high-speed interfaces



aaa-014159

Test frequency: 148.5 MHz
Differential swing voltage: 810 mV
Horizontal scale: 34 ps/div

Fig 7. HDMI 2.0 TP1 eye diagram, PCB with PUSB3F97 (2160p, 60 Hz)

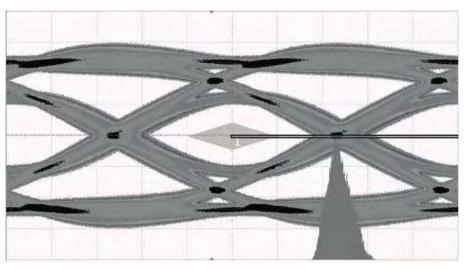


aaa-014160

Test frequency: 148.5 MHz Differential swing voltage: 800 mV Horizontal scale: 34 ps/div

Fig 8. HDMI 2.0 TP1 eye diagram, PCB without PUSB3F97 (2160p, 60 Hz, reference)

ESD protection for ultra high-speed interfaces

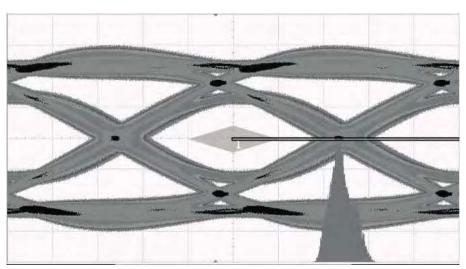


aaa-014161

Test frequency: 148.5 MHz Differential swing voltage: 809 mV Horizontal scale: 34 ps/div

Remark: Measured at Test Point 2 (TP2) worst cable emulator, reference cable equalizer and worst case positive skew.

Fig 9. HDMI 2.0 TP2 eye diagram, PCB with PUSB3F97 (2160p, 60 Hz)



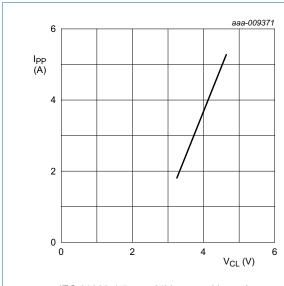
aaa-014162

Test frequency: 148.5 MHz Differential swing voltage: 820 mV Horizontal scale: 34 ps/div

Remark: Measured at Test Point 2 (TP2) worst cable emulator, reference cable equalizer and worst case positive skew.

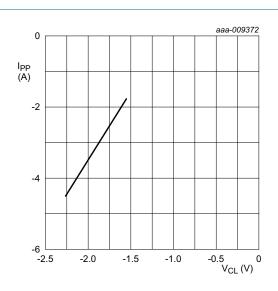
Fig 10. HDMI 2.0 TP2 eye diagram, PCB without PUSB3F97 (2160p, 60 Hz, reference)

ESD protection for ultra high-speed interfaces



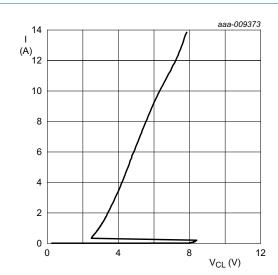
IEC 61000-4-5; t_p = 8/20 μ s; positive pulse

Fig 11. Dynamic resistance with positive clamping; typical values



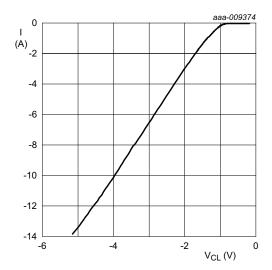
IEC 61000-4-5; $t_p = 8/20 \mu s$; negative pulse

Fig 12. Dynamic resistance with negative clamping; typical values



 t_p = 100 ns; Transmission Line Pulse (TLP) Fig 13. Dynamic resistance with positive clamping;

typical values



t_p = 100 ns; Transmission Line Pulse (TLP)

Fig 14. Dynamic resistance with negative clamping; typical values

The device uses an advanced clamping structure showing a negative dynamic resistance. This snap-back behavior strongly reduces the clamping voltage to the system behind the ESD protection during an ESD event. Do not connect unlimited DC current sources to the data lines to avoid keeping the ESD protection device in snap-back state after exceeding breakdown voltage (due to an ESD pulse for instance).

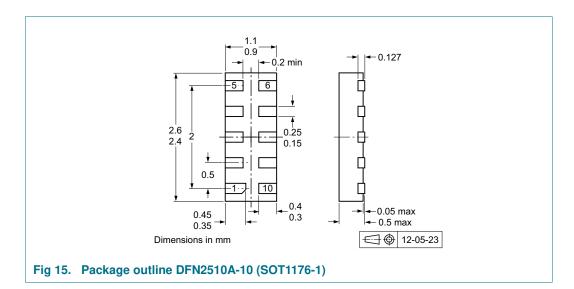
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7. Application information

The device is designed to provide high-level ESD protection for high-speed serial data buses such as USB3.1, HDMI, DisplayPort, eSATA and LVDS data lines.

When designing the Printed-Circuit Board (PCB), give careful consideration to impedance matching and signal coupling. Do not connect the signal lines to unlimited current sources like, for example, a battery.

8. Package outline



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9. Soldering

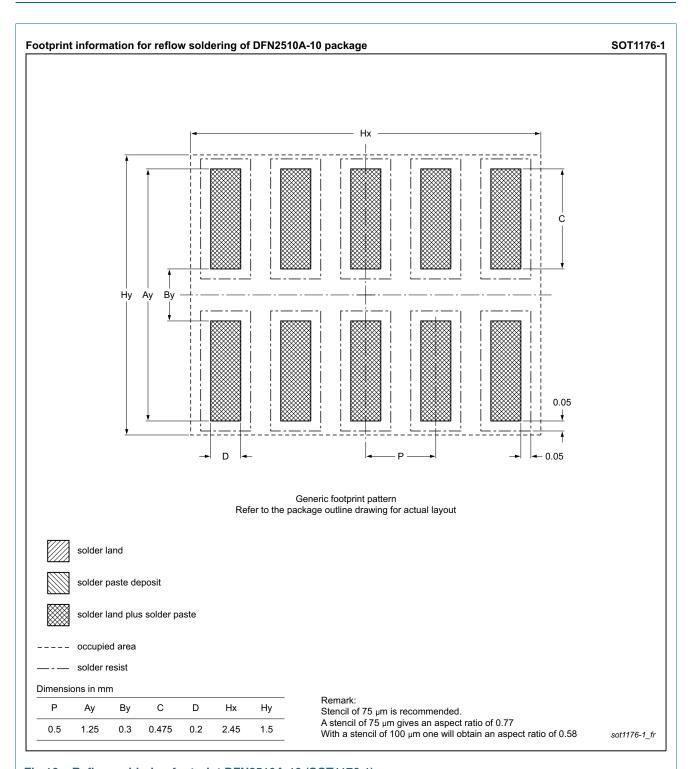


Fig 16. Reflow soldering footprint DFN2510A-10 (SOT1176-1)

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10. Revision history

Table 6. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PUSB3F97 v.1	20170510	Product data sheet	-	-

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11. Legal information

11.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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PUSB3F97

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